

HM237080000G Information


For Reference Only

Part Number [HM237080000G](#)
Manufacturer Amphenol Anytek
Category Connectors, Interconnects
[Terminal Blocks - Wire to Board](#)
Description 500 TB SP CLA DIP SOLDER
Package -
 For the pricing/inventory/lead time, please contact us
 Website: <https://www.heisener.com>
 E-mail: salesdept@heisener.com



[Request a Quote](#)

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.


HM237080000G Specifications

Manufacturer Part Number	HM237080000G
Manufacturer	Amphenol Anytek
Category	Connectors, Interconnects Terminal Blocks - Wire to Board
Package	-
Series	HM
Number of Levels	1
Positions Per Level	23
Pitch	0.197" (5.00mm)
Mating Orientation	Vertical with Board
Current	8A
Voltage	250V
Wire Gauge	12-28 AWG
Mounting Type	Through Hole
Wire Termination	Screwless - Leg Spring, Push-In Spring
Features	Interlocking (Side)
Color	Gray

[Report errors?](#)

HM237080000G Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

HM237080000G Payment Methods



HM237080000G Shipping Methods



If you have any question about HM237080000G, please do not hesitate to contact us!

Website: <https://www.heisener.com>

E-mail: salesdept@heisener.com